# FDN338P

November 2013

# FDN338P

FAIRCHILD SEMICONDUCTOR IN

# P-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

# **General Description**

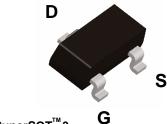
This P-Channel 2.5V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management applications.

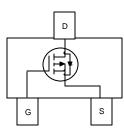
# **Applications**

- Battery management
- Load switch
- Battery protection

# Features

- -1.6 A, -20 V.  $R_{DS(ON)} = 115 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$  $R_{DS(ON)} = 155 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
- Fast switching speed
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- SuperSOT<sup>TM</sup> -3 provides low  $R_{DS(ON)}$  and 30% higher power handling capability than SOT23 in the same footprint





# SuperSOT<sup>™</sup>-3

# Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
l <sub>D</sub>	Drain Current – Continuous		-1.6	A
	- Pulsed		-5	
PD	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W

# **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape width	Quantity
338	FDN338P	7"	8mm	3000 units

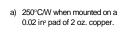
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-20			V
$\Delta BV_{DSS} \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$l_{\rm D}$ = -250 µA, Referenced to 25°C		-16		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$ , $V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.8	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		2.7		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V,  I_D = -1.6 \ A \\ V_{GS} = -2.5 \ V,  I_D = -1.3 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -1.6 \ A, \ T_J = 125^\circ C \end{array} $		88 117 116	115 155 165	mΩ
D(on)	On–State Drain Current	$V_{GS} = -4.5 V$ , $V_{DS} = -5 V$	-5			Α
<b>g</b> fs	Forward Transconductance	$V_{DS} = -5 V$ , $I_D = -1.6 A$		6		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 V$ , $V_{GS} = 0 V$ ,		451		pF
Coss	Output Capacitance	f = 1.0 MHz		75		pF
Crss	Reverse Transfer Capacitance			33		pF
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -10 V$ , $I_D = -1 A$ ,		10	20	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$		11	20	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			16	29	ns
t <sub>f</sub>	Turn–Off Fall Time			6.5	13	ns
Qg	Total Gate Charge	$V_{DS} = -10 \text{ V},  I_D = -1.6 \text{ A},$		4.4	6.2	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = -4.5 V$		1.1		nC
Q <sub>gd</sub>	Gate–Drain Charge			0.7		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source				-0.42	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_S = -0.42$ (Note 2)		-0.7	-1.2	V

 R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

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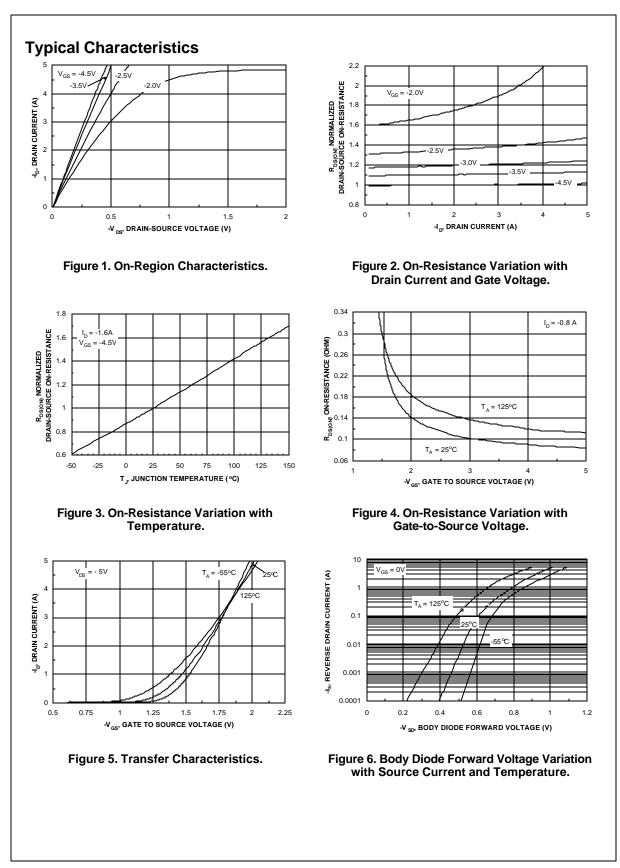


b) 270°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

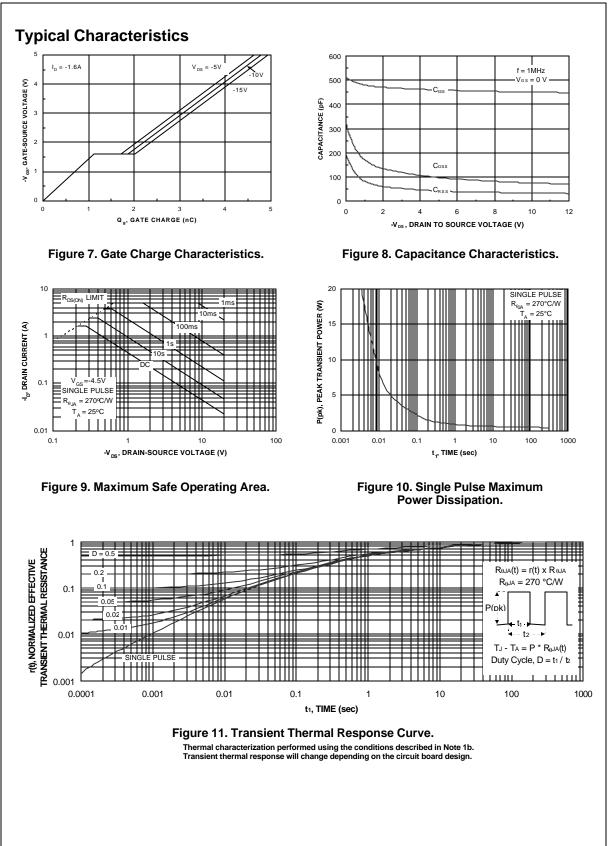
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2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%



FDN338P

FDN338P Rev F1(W)



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FDN338P Rev F1(W)



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